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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/537,959	06/07/2005	Shigeru Tanaka	81844.0036	1391
260/21	7590	11/26/2010		
Hogan Lovells US LLP			EXAMINER	
1999 AVENUE OF THE STARS			LISTVOYB, GREGORY	
SUITE 1400				
LOS ANGELES, CA 90067			ART UNIT	PAPER NUMBER
			1765	
			NOTIFICATION DATE	DELIVERY MODE
			11/26/2010	ELECTRONIC

**Please find below and/or attached an Office communication concerning this application or proceeding.**

The time period for reply, if any, is set in the attached communication.

Notice of the Office communication was sent electronically on above-indicated "Notification Date" to the following e-mail address(es):

LAUSPTO@hhlaw.com  
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<b>Office Action Summary</b>	<b>Application No.</b>	<b>Applicant(s)</b>
	10/537,959	TANAKA ET AL.
	<b>Examiner</b> GREGORY LISTVOYB	<b>Art Unit</b> 1765

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --  
**Period for Reply**

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If no period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED. (35 U.S.C. § 133).

Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

**Status**

1) Responsive to communication(s) filed on **24 May 2010**.

2a) This action is **FINAL**.      2b) This action is non-final.

3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

**Disposition of Claims**

4) Claim(s) **12-15** is/are pending in the application.

4a) Of the above claim(s) \_\_\_\_\_ is/are withdrawn from consideration.

5) Claim(s) \_\_\_\_\_ is/are allowed.

6) Claim(s) **12-15** is/are rejected.

7) Claim(s) \_\_\_\_\_ is/are objected to.

8) Claim(s) \_\_\_\_\_ are subject to restriction and/or election requirement.

**Application Papers**

9) The specification is objected to by the Examiner.

10) The drawing(s) filed on \_\_\_\_\_ is/are: a) accepted or b) objected to by the Examiner.  
 Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).  
 Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).

11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

**Priority under 35 U.S.C. § 119**

12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).

a) All    b) Some \* c) None of:

1. Certified copies of the priority documents have been received.
2. Certified copies of the priority documents have been received in Application No. \_\_\_\_\_.
3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

\* See the attached detailed Office action for a list of the certified copies not received.

**Attachment(s)**

1) Notice of References Cited (PTO-892)  
 2) Notice of Draftsperson's Patent Drawing Review (PTO-948)  
 3) Information Disclosure Statement(s) (PTO/SB/08)  
 Paper No(s)/Mail Date \_\_\_\_\_

4) Interview Summary (PTO-413)  
 Paper No(s)/Mail Date. \_\_\_\_\_

5) Notice of Informal Patent Application  
 6) Other: \_\_\_\_\_

## **DETAILED ACTION**

### ***Continued Examination Under 37 CFR 1.114***

A request for continued examination under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on 5/24/2010 has been entered.

### ***Claim Rejections - 35 USC § 102***

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless –

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

Claims 12-15 rejected under 35 U.S.C. 102(b) as being anticipated by unpatentable over Katsuki et al (US 2003/0049487) or Oguni et al (US 2003/017041).

Katsuki discloses a polyimide film and laminate (meeting the limitations of claim 13-15, see Katsuki's claims 4, 8,10).

Katsuki teaches both surface layers having protrusions with average height of 0.03 to 0.1 um in terms of Ra (see Claims 8 and 9).

Note that Katsuki does not teach Ra1/Ra2 ratio, cutoff value and Ra2 value.

However, Katsuki discloses very high peeling strength (6.7-15.4 N/cm, see Table 1), which is in the same range of the claimed laminate (8-11 N/cm, see Table 4 of the Application examined).

Oguni et al teach a metal-coated polyimide film for use in producing printed circuit boards wherein the metal layer is formed by electroless plating a metal, such as copper, on a heat-resistant polyimide adhesive layer formed on a heat-resistant resin film and the coated film exhibits high heat resistance and high adhesion (Abstract; Paragraphs 0005 and 0029.) Oguni et al teach that the polyimide adhesive is formed from a polyimide resin produced from a precursor solution composed mainly of aromatic tetracarboxylic acid dianhydride and siloxane- type diamine having the structure as shown in formula I which reads upon the claimed structure, and has an elastic modulus of 0.1 to 3.0 GPa at 200°C, more preferably 0.3 GPa to 2.0 GPa (Paragraphs 0015-0023.) Oguni et al teach that the polyimide adhesive layer has a thickness of 0.01 to 10 microns, preferably 0.01 to 5 microns, and more preferably 0.01 to 3 microns (Paragraph 0019; wherein the Examiner takes the position that the Ra surface roughness of the polyimide adhesive films at the lower end of the thickness range taught by Oguni et al would fall within the claimed Ra range and hence reads upon the claims.) Oguni et al further teach that the adhesion of the metal layer to the polyimide adhesive as obtained by peeling as described in Paragraph 0033 is preferably 5 N/cm or more, preferably 10 N/cm or more (Paragraph 0033).

The claiming of a new use, new function or unknown property, which is inherently present in the prior art, does not necessarily make the claim patentable. *In re Best*, 562 F.2d 1252, 1254, 195 USPQ 430, 433 (CCPA 1977).

***Response to Arguments***

Applicant's arguments with respect to claims 12-15 have been considered but are moot in view of the new ground(s) of rejection.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to GREGORY LISTVOYB whose telephone number is (571)272-6105. The examiner can normally be reached on 10am-7pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, James Seidleck can be reached on (571) 272-1078. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

GL  
/GREGORY LISTVOYB/  
Examiner, Art Unit 1765